# **-OP \$40.00 112**

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT	
	Corrective Assignment to correct the Assignee previously recorded on Reel 016985 Frame 0638. Assignor(s) hereby confirms the to correct the Assignee from "M-MOS SDN. BHD." to "M-MOS Semiconductor SDN. BHD.".	

### **CONVEYING PARTY DATA**

Name	Execution Date
Fwu-luan Hshieh	09/05/2005

### **RECEIVING PARTY DATA**

Name:	M-MOS Semiconductor SDN. BHD	
Street Address:	1 Silicon Drive, Sama Jaya Free Industrial Zone	
City:	93350 Kuching, Sarawak	
State/Country:	MALAYSIA	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11223621

### **CORRESPONDENCE DATA**

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Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Address Line 4: Los Altos Hills, CALIFORNIA 94022

ATTORNEY DOCKET NUMBER: MMOS-0505

ATTORNEY DOCKET NUMBER: MMOS-0505

NAME OF SUBMITTER: Bo-In Lin

**Total Attachments: 2** 

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PATENT REEL: 021245 FRAME: 0822

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ت گ	Form <b>PTO-1595</b> (Rev. 10/02) OMB No. 0651-0027 (exp. 6/30/2005)	DECO HIDEON		U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office	
	Tab settings ⇔⇔ ♥	▼ 103	3083884	▼ ▼	
				riginal documents or copy thereof.	
سی	1. Name of conveying party(ies): Fwu-Iuan Hshieh		Name: M MOC -	of receiving party(ies)  Idn. Bhd. C.L. 7/16/08  Conductor San. a.T.  Bhd. cig.	
	Additional name(s) of conveying party(ies) attached? 🖵 Yes 🌠 No			75.	
		ottodiod: Cal 100 Cal 110		1,1	
ļ	3. Nature of conveyance:	<b>-</b>			
	Assignment  Security Agreement	☐ Merger ☐ Change of Name	Street Address: 1_	Silicon Drive	
	-	Change of Name	Sama Java Fr	ee Industrial Zone	
	Other		93350 Kuchin	ng, Sarawak, Malaysia State: Zip:	
	Execution Date: Sept. 5, 2005		Additional name(s) & ad	ldress(es) attached? 📮 Yes 🛂 No	
	If this document is being filed to     A. Patent Application No.(s)		ication, the execution da  B. Patent No.(s)  B. Patent No.(s)	te of the application is: <u>\$2005</u>	
				lications and patents involved:	
				.41)\$ 40.00	
	Name: Bo-In Lin			.41/	
	Internal Address:		Enclosed		
			Authorized to b	e charged to deposit account	
	9/16/2005 ECROPER 00000113 11223621 1 FC:0021 40.00 (P Street Address: 13445 Mandoli Drive		8. Deposit account nu	mber:	
	CityLos Altos Hills, CA	Zip: 94022	(Attach duplicate copy of	this page if paying by deposit account)	
		DO NOT USE	THIS SPACE		
	<ol> <li>Statement and signature.</li> <li>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</li> </ol>				
Ching-lu Lin			wo-lu	_ Sept. 10, 2005	
	Name of Person Signin	g	Signature	Date	
	Total nu	cuments: 2			

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

## Docket No.MMOS-0505

1384

### ASSIGNMENT

INVENTOR

Whereas, I, Fwu-Iuan Hshieh of

AND CITY

Saratoga, California 95070

have invented:

TITLE:

HIGH DENSITY HYBRID MOSFET DEVICE

DATE INVENTOR SIGNED THE DECLARATION

and executed a United States patent application therefor

on 3/5 2005; (Z7/16/08) M-MOS Semiconductor Sala. Bld.

Whereas, M-MOS Sdn. Bhd., having a place of business at Sarawak, Malaysia, (hereinafter called M-MOS), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to M-MOS, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to M-MOS its successors and assigns; and I hereby agree that M-MOS may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sarawak, Malaysia

DATE

SIGNATURE OF INVENTOR

PATENT REEL: 021245 FRAME: 0824

**RECORDED: 07/16/2008**